

DS26C32AMQML Quad Differential Line Receiver

Check for Samples: [DS26C32AMQML](#)

FEATURES

- CMOS Design for Low Power
- $\pm 0.2\text{V}$ Sensitivity Over Input Common Mode Voltage Range
- Input Fail-Safe Circuitry
- Inputs Won't Load Line When $V_{CC} = 0\text{V}$
- Meets the Requirements of EIA Standard RS-422
- TRI-STATE Outputs for Connection to System Buses

DESCRIPTION

The DS26C32A is a quad differential line receiver designed to meet the RS-422, RS-423, and Federal Standards 1020 and 1030 for balanced and unbalanced digital data transmission, while retaining the low power characteristics of CMOS.

The DS26C32A has an input sensitivity of 200 mV over the common mode input voltage range of $\pm 7\text{V}$. The DS26C32A features internal pull-up and pull-down resistors which prevent output oscillation on unused channels.

The DS26C32A provides an enable and disable function common to all four receivers, and features TRI-STATE outputs with 6 mA source and sink capability. This product is pin compatible with the DS26LS32A and the AM26LS32.

CONNECTION DIAGRAMS

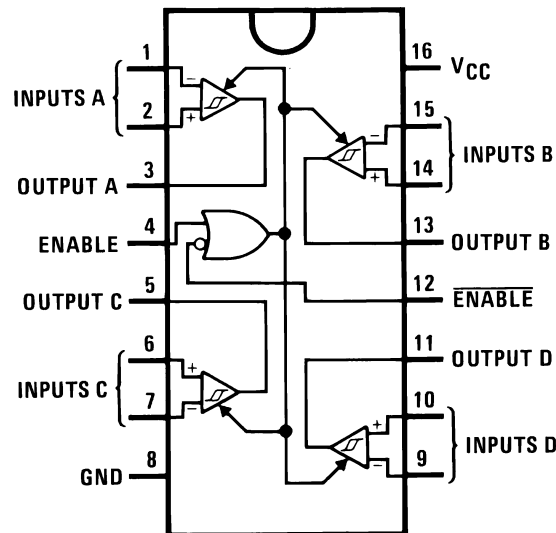


Figure 1. CDIP and CLGA Packages-Top View
See Package Numbers NFE0016A, NAC0016A, or NAD0016A



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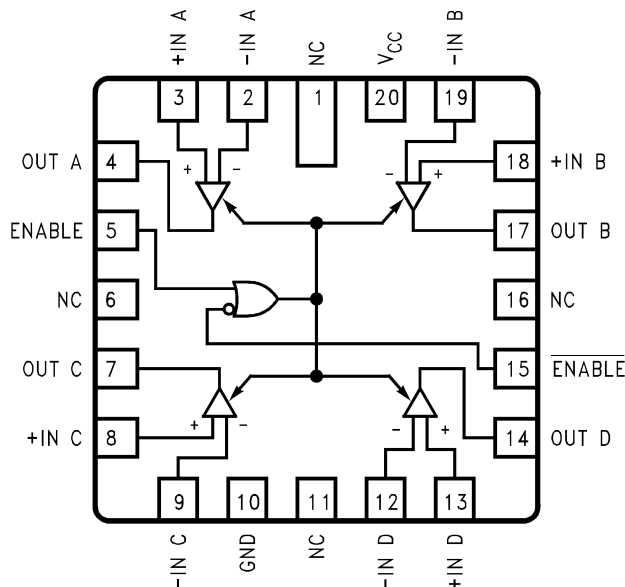
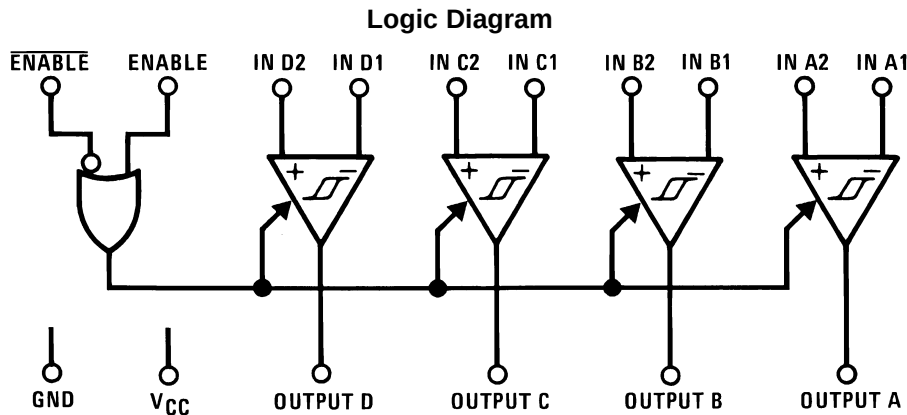


Figure 2. 20-Lead LCCC Package-Top View
See Package Number NAJ0020A



Truth Table (1)

ENABLE	ENABLE	Input	Output
L	H	X	Z
All Other Combinations of Enable Inputs		$V_{ID} \geq V_{Th} \text{ (Max)}$	H
		$V_{ID} \leq V_{Th} \text{ (Min)}$	L
		Open	H

(1) Z = TRI-STATE



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings⁽¹⁾⁽²⁾

Supply Voltage (V_{CC})	7V
Common Mode Range (V_{CM})	$\pm 14V$
Differential Input Voltage (V_{Diff})	$\pm 14V$
Enable Input Voltage (V_I)	7V
Storage Temperature Range (T_{stg})	$-65^{\circ}C \leq T_A \leq +150^{\circ}C$
Lead Temperature (Soldering 4 sec.)	260°C

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not verify specific performance limits. For verified specifications and test conditions, see the Electrical Characteristics. The verified specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) Unless otherwise specified, all voltages are referenced to ground.

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V_{CC})	4.50	5.50	V
Operating Temperature Range (T_A)	-55	+125	°C

Quality Conformance Inspection

Table 1. Mil-Std-883, Method 5005 - Group A

Subgroup	Description	Temp °C
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55
12	Settling time at	+25
13	Settling time at	+125
14	Settling time at	-55

DS26C32AM Electrical Characteristics DC Parameters

Parameter	Test Conditions	Notes	Min	Max	Unit	Sub-groups
V_{TH}	Minimum Differential Input Voltage	$V_{CC} = 5V, V_O = V_{OH} \text{ or } V_{OL}, -7 < V_{CM} < +7$	-200	+200	mV	1, 2, 3
R_I	Input Resistance	$V_{CC} = 5V, -7 < V_{CM} < +7$, One input AC Gnd	4.5	11	K Ω	1, 2, 3
I_I	Input Current	$V_{CC} = 5V, V_I = +10V$, Other Input = Gnd		+1.8	mA	1, 2, 3
		$V_{CC} = 5V, V_I = -10V$, Other Input = Gnd		-2.7	mA	1, 2, 3
V_{OH}	Logical "1" Output Voltage	$V_{CC} = 4.5V, V_{Diff} = +1V$, $I_O = -6.0mA$	3.8		V	1, 2, 3
V_{OL}	Logical "0" Output Voltage	$V_{CC} = 5.5V, V_{CC} = \text{Max}$, $V_{Diff} = -1V, I_O = 6.0mA$		0.3	V	1, 2, 3

DS26C32AM Electrical Characteristics DC Parameters (continued)

Parameter		Test Conditions	Notes	Min	Max	Unit	Sub-groups
V_{IH}	Minimum Enable High Level Voltage		(1)	2.0		V	1, 2, 3
V_{IL}	Maximum Enable Low Level Voltage		(1)		0.8	V	1, 2, 3
I_{OZ}	Maximum TRI-STATE Output Leakage Current	$V_O = V_{CC}$ or Gnd, $\overline{\text{Enable}} = V_{IL}$, $\text{Enable} = V_{IH}$			± 5.0	μA	1, 2, 3
I_I	Maximum Enable Input Current	$V_I = V_{CC}$ or Gnd			± 1.0	μA	1, 2, 3
I_{CC}	Quiescent Power Supply Current	$V_{Diff} = +1\text{V}$, $V_{CC} = 5.5\text{V}$			25	mA	1, 2, 3

(1) Parameter tested Go-No-Go only.

DS26C32AM Electrical Characteristics AC Parameters - Propagation Delay TimeThe following conditions apply, unless otherwise specified. $V_{CC} = 5\text{V} \pm 10\%$, $C_{CL} = 50\text{pF}$, $V_{Diff} = 2.5\text{V}$

Parameter		Test Conditions	Notes	Min	Max	Unit	Sub-groups
t_{PLH}	Input to Output Prop Delay	$V_{CM} = 0\text{V}$			35	ns	9, 10, 11
t_{PHL}	Input to Output Prop Delay	$V_{CM} = 0\text{V}$			35	ns	9, 10, 11
t_{Rise}	Output Rise Time	$V_{CM} = 0\text{V}$			9	ns	9, 10, 11
t_{Fall}	Output Fall Time	$V_{CM} = 0\text{V}$			9	ns	9, 10, 11
t_{PLZ}	Output Disable Time	$R_L = 1000\Omega$			29	ns	9, 10, 11
t_{PZL}	Output Enable Time	$R_L = 1000\Omega$			29	ns	9, 10, 11
t_{PHZ}	Output Disable Time	$R_L = 1000\Omega$			29	ns	9, 10, 11
t_{PZH}	Output Enable Time	$R_L = 1000\Omega$			29	ns	9, 10, 11

Typical Performance Characteristics

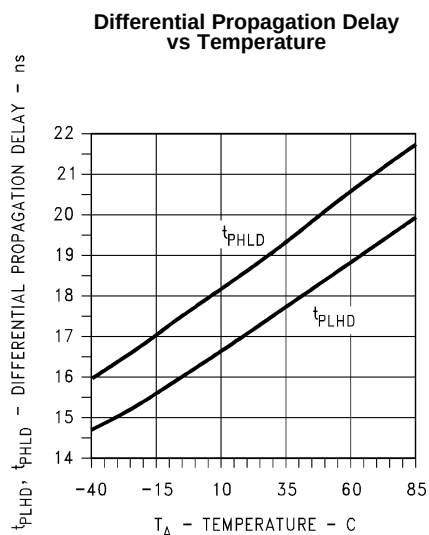


Figure 3.

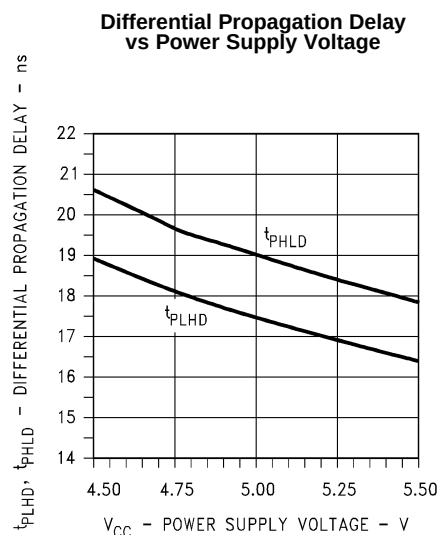


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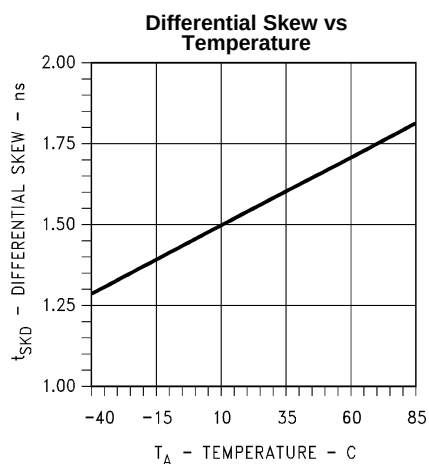


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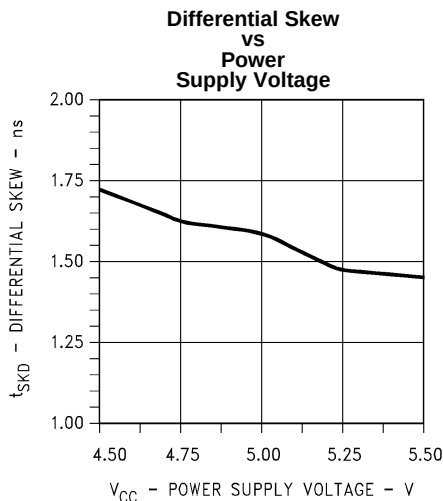


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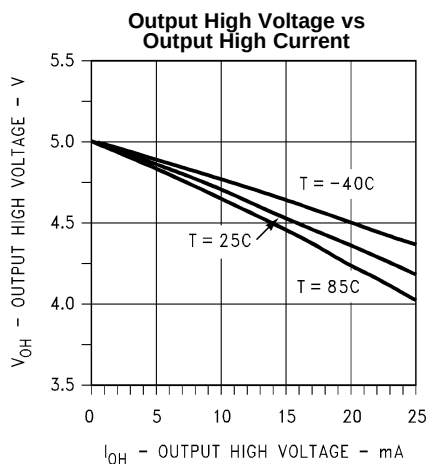


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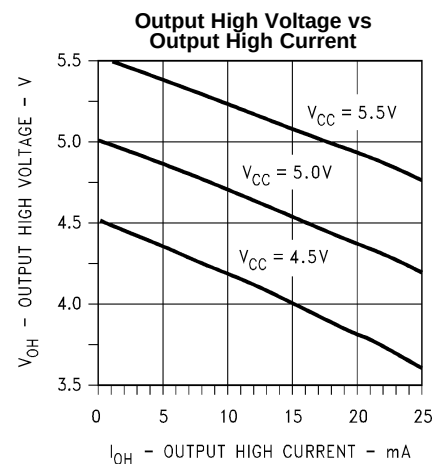


Figure 8.

Typical Performance Characteristics (continued)

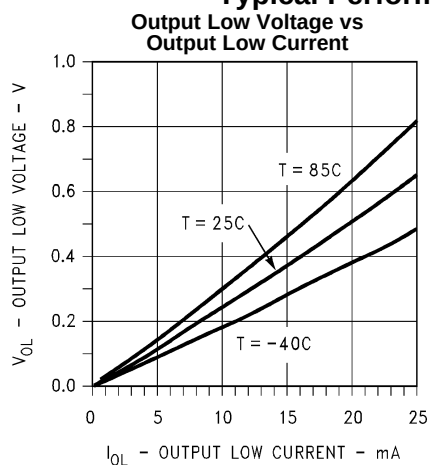


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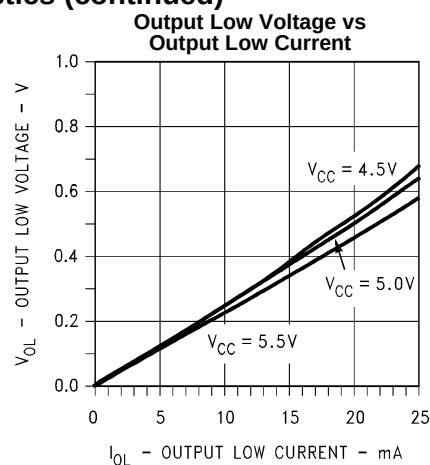


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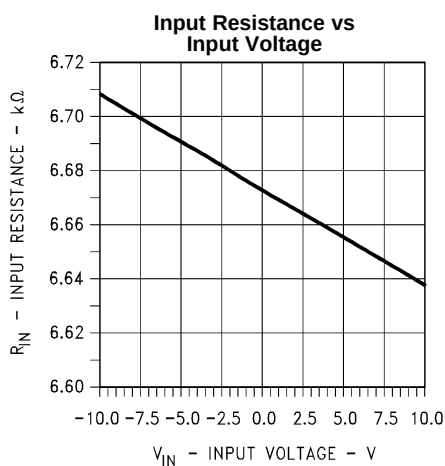


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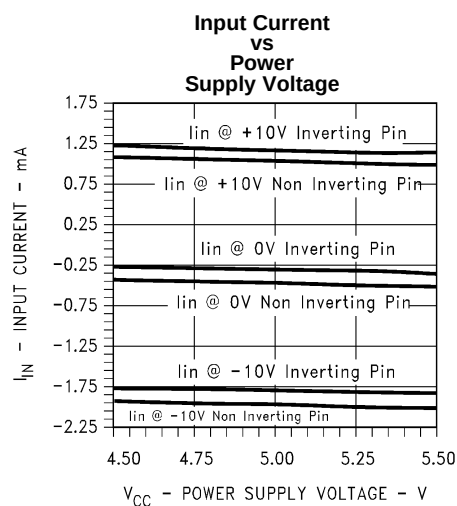


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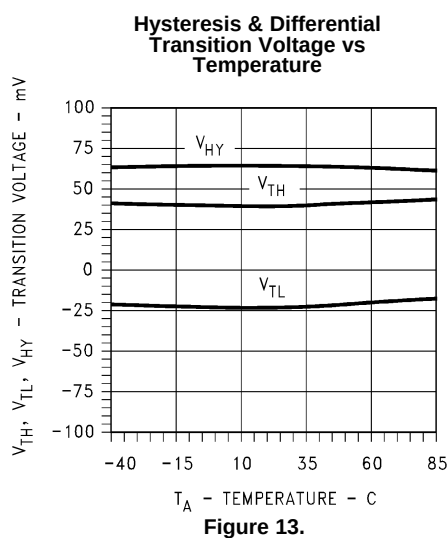


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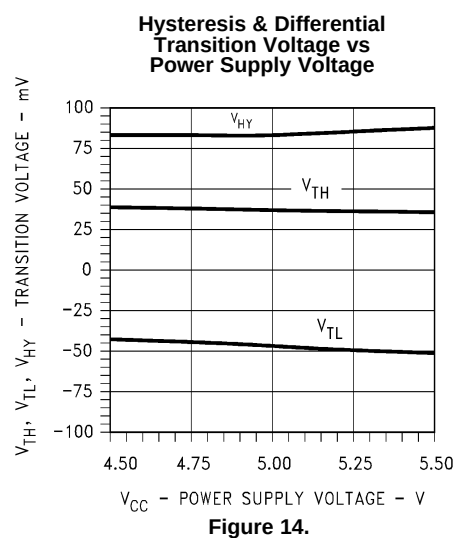


Figure 14.

Typical Performance Characteristics (continued)

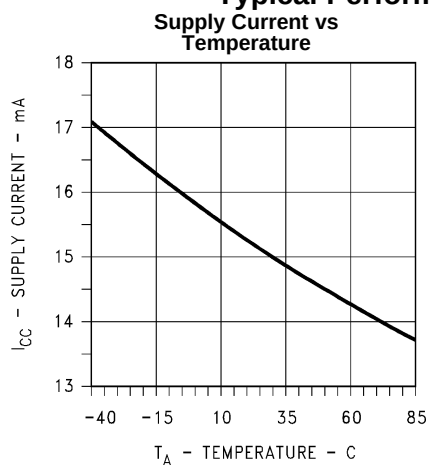


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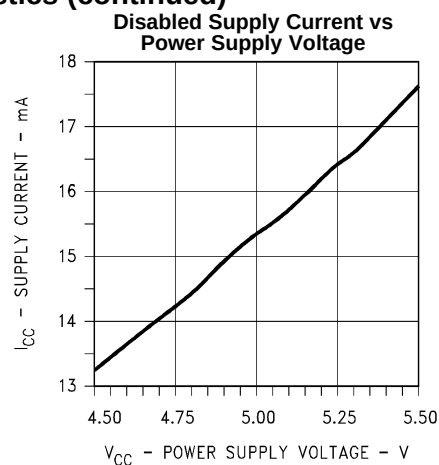


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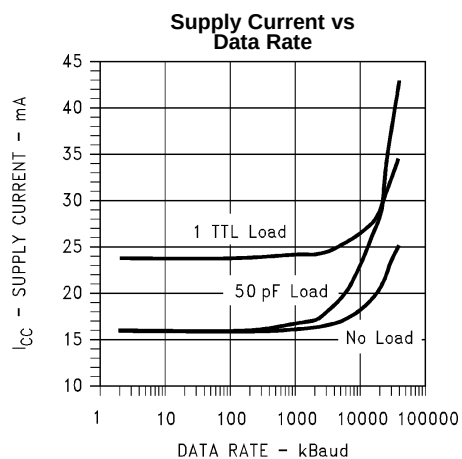
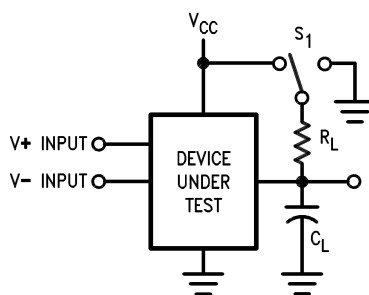


Figure 17.

AC TEST CIRCUIT AND SWITCHING TIME WAVEFORMS



C_L includes load and test jig capacitance.
 $S_1 = V_{CC}$ for t_{PZL} and t_{PLZ} measurements.
 $S_1 = \text{Gnd}$ for t_{PZH} and t_{PHZ} measurements.

Figure 18. Test Circuit for TRI-STATE Output Tests

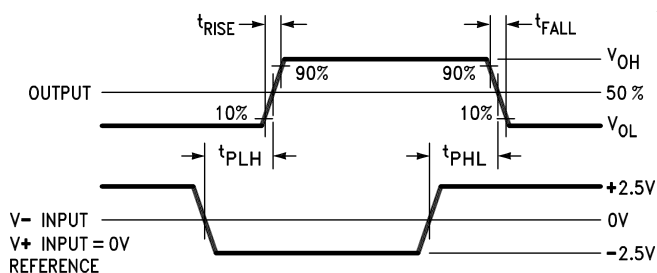


Figure 19. Propagation Delay

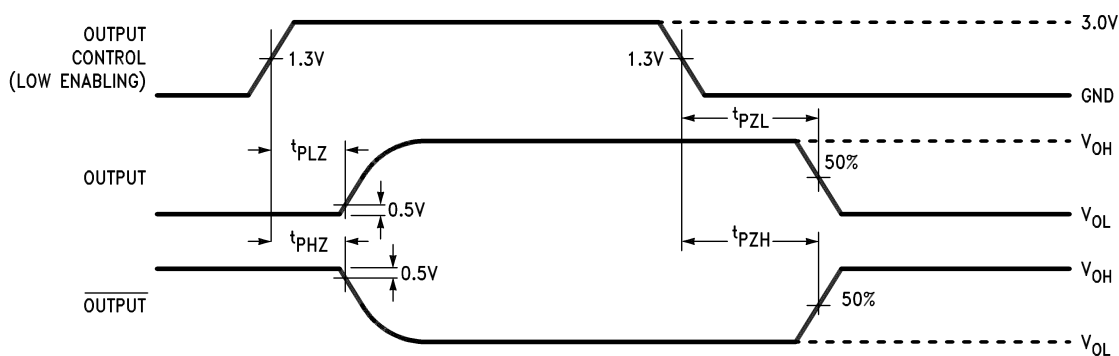
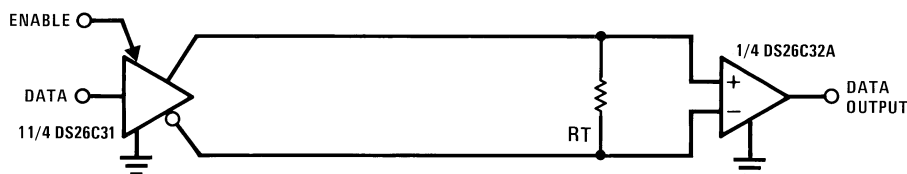


Figure 20. TRI-STATE Output Enable and Disable Waveforms

TYPICAL APPLICATIONS

Figure 21. Two-Wire Balanced Systems, RS-422



REVISION HISTORY

Released	Revision	Section	Changes
10/26/2010	*	New Release, Corporate format	MDS data sheets converted into one Corp. data sheet format. MNDS26C32AM-X Rev 0B0 will be archived.
4/15/2013	A		Changed layout of National Data Sheet to TI format

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-9164001M2A	Active	Production	LCCC (NAJ) 20	50 TUBE	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	DS26C32AME /883 Q 5962-91640 01M2A ACO 01M2A >T
5962-9164001MEA	Active	Production	CDIP (NFE) 16	25 TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	DS26C32AMJ/883 5962-9164001MEA Q
5962-9164001MFA	Active	Production	CFP (NAD) 16	19 TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	DS26C32AMW /883 Q 5962-91640 01MFA ACO 01MFA >T
5962-9164001MXA	Active	Production	CFP (NAC) 16	88 JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	DS26C32AMWG /883 Q 5962-91640 01MXA ACO 01MXA >T
DS26C32A MD8	Active	Production	DIESALE (Y) 0	100 JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
DS26C32A-MD8.A	Active	Production	DIESALE (Y) 0	100 JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
DS26C32AME/883	Active	Production	LCCC (NAJ) 20	50 TUBE	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	DS26C32AME /883 Q 5962-91640 01M2A ACO 01M2A >T
DS26C32AME/883.A	Active	Production	LCCC (NAJ) 20	50 TUBE	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	DS26C32AME /883 Q 5962-91640 01M2A ACO 01M2A >T
DS26C32AMJ/883	Active	Production	CDIP (NFE) 16	25 TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	DS26C32AMJ/883 5962-9164001MEA Q
DS26C32AMJ/883.A	Active	Production	CDIP (NFE) 16	25 TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	DS26C32AMJ/883 5962-9164001MEA Q

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
DS26C32AMW/883	Active	Production	CFP (NAD) 16	19 TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	DS26C32AMW /883 Q 5962-91640 01MFA ACO 01MFA >T
DS26C32AMW/883.A	Active	Production	CFP (NAD) 16	19 TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	DS26C32AMW /883 Q 5962-91640 01MFA ACO 01MFA >T
DS26C32AMW/883.B	Active	Production	CFP (NAD) 16	19 TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	DS26C32AMW /883 Q 5962-91640 01MFA ACO 01MFA >T
DS26C32AMWG/883	Active	Production	CFP (NAC) 16	88 JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	DS26C32AMWG /883 Q 5962-91640 01MXA ACO 01MXA >T
DS26C32AMWG/883.A	Active	Production	CFP (NAC) 16	88 JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	DS26C32AMWG /883 Q 5962-91640 01MXA ACO 01MXA >T

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

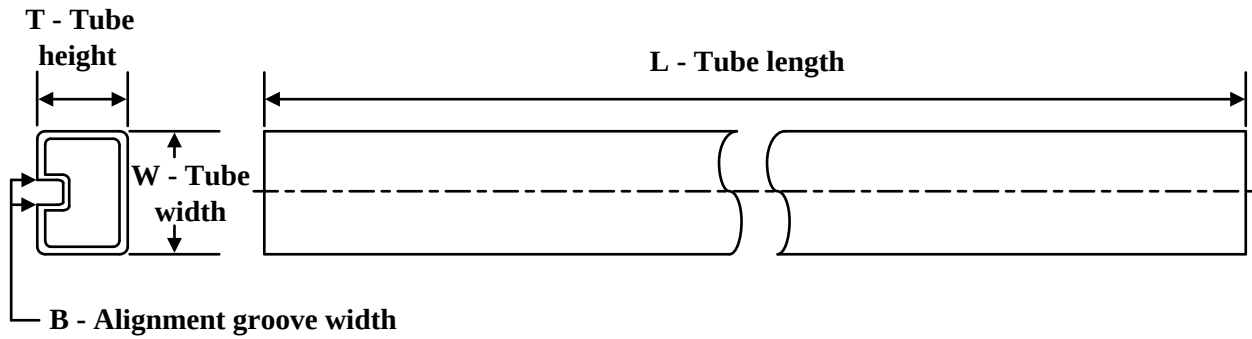
⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

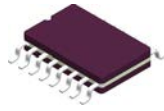
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TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
5962-9164001M2A	NAJ	LCCC	20	50	470	11	3810	0
5962-9164001MEA	NFE	CDIP	16	25	506.98	15.24	13440	NA
5962-9164001MFA	NAD	CFP	16	19	502	23	9398	9.78
DS26C32AME/883	NAJ	LCCC	20	50	470	11	3810	0
DS26C32AME/883.A	NAJ	LCCC	20	50	470	11	3810	0
DS26C32AMJ/883	NFE	CDIP	16	25	506.98	15.24	13440	NA
DS26C32AMJ/883.A	NFE	CDIP	16	25	506.98	15.24	13440	NA
DS26C32AMW/883	NAD	CFP	16	19	502	23	9398	9.78
DS26C32AMW/883.A	NAD	CFP	16	19	502	23	9398	9.78
DS26C32AMW/883.B	NAD	CFP	16	19	502	23	9398	9.78

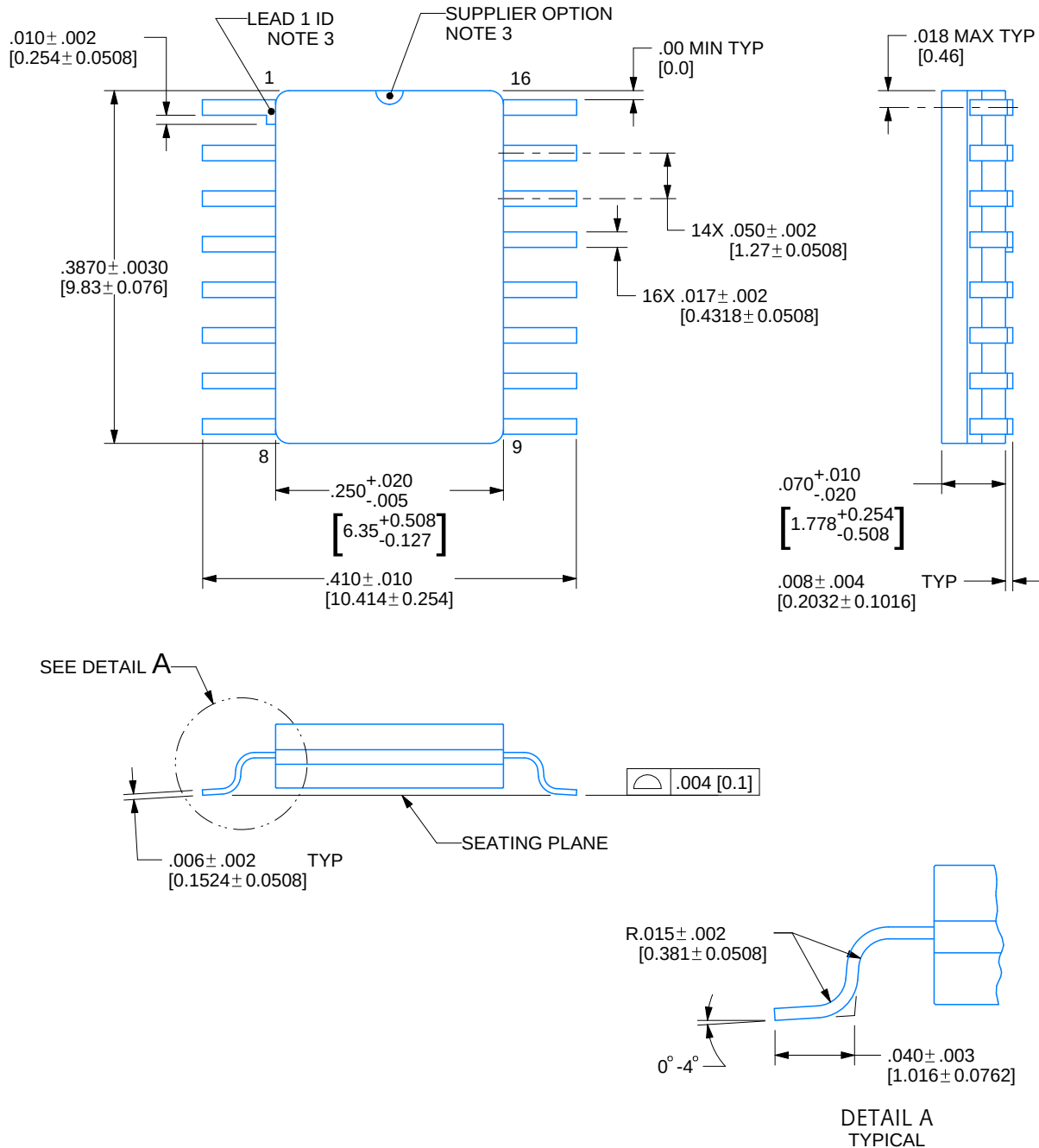


NAC0016A

PACKAGE OUTLINE

CFP - 2.33mm max height

CERAMIC FLATPACK



4215198/C 08/2022

NOTES:

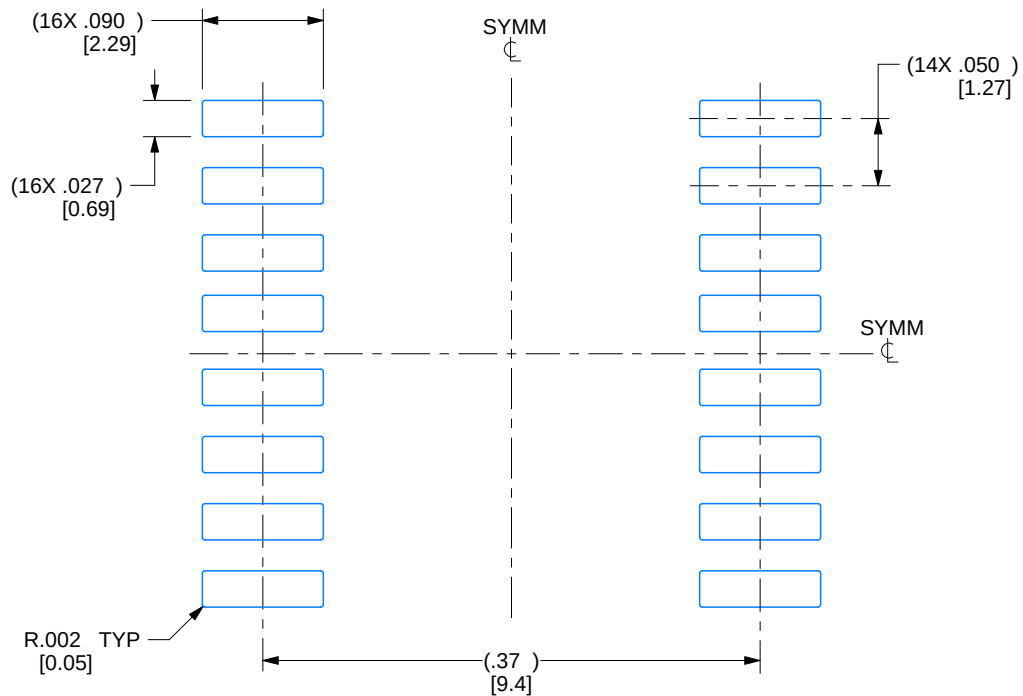
- Controlling dimension is Inch. Values in [] are millimeters. Dimensions in () for reference only.
- For solder thickness and composition, see the "Lead Finish Composition/Thickness" link in the packaging section of the Texas Instruments website
- Lead 1 identification shall be:
 - A notch or other mark within this area
 - A tab on lead 1, either side
- No JEDEC registration as of December 2021

EXAMPLE BOARD LAYOUT

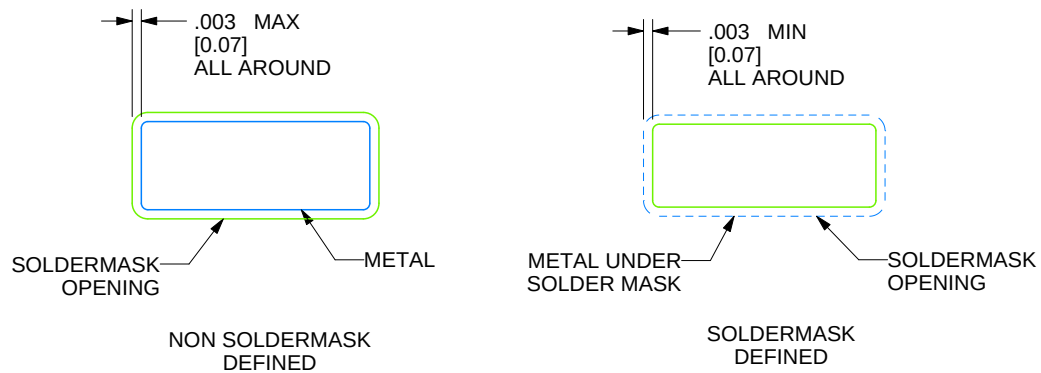
NAC0016A

CFP - 2.33mm max height

CERAMIC FLATPACK



RECOMMENDED LAND PATTERN

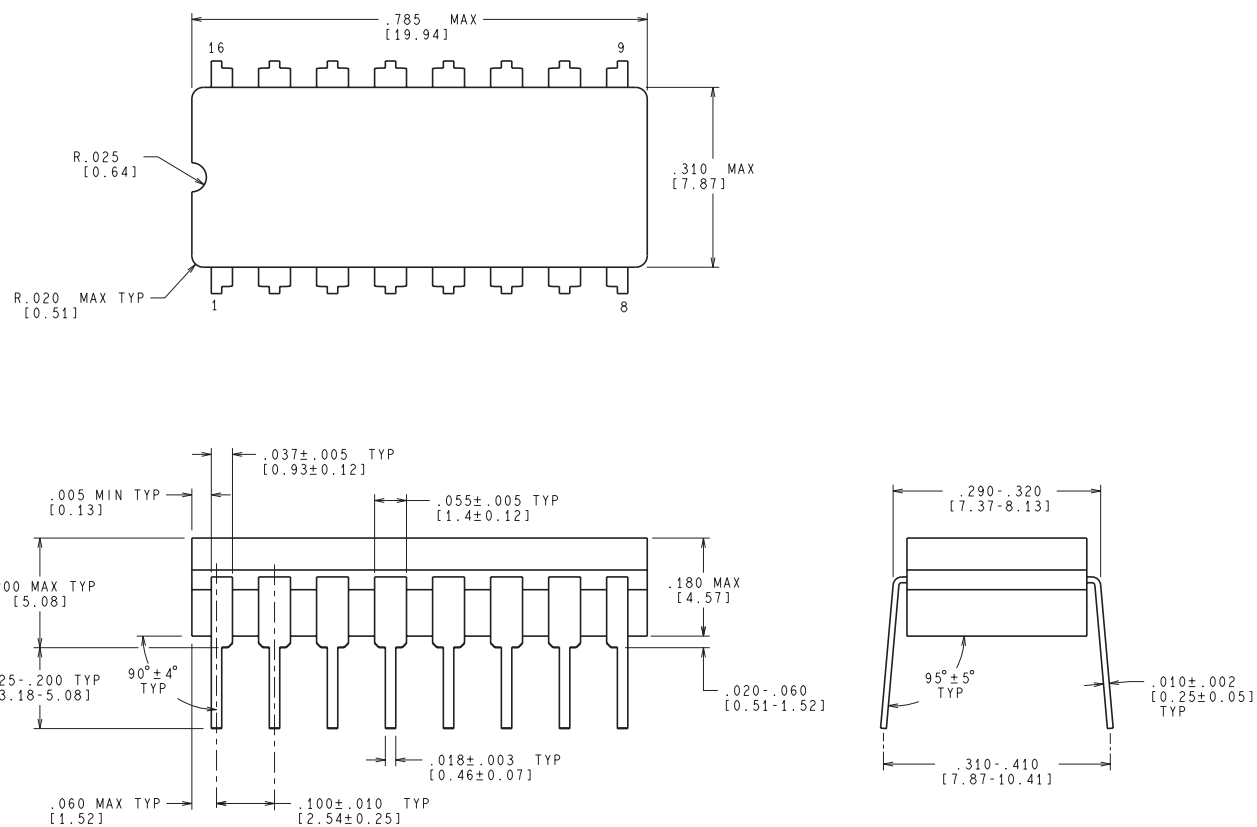


4215198/C 08/2022

REVISIONS

REV	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	2197879	12/30/2021	TINA TRAN / ANIS FAUZI
B	NO CHANGE TO DRAWING; REVISION FOR YODA RELEASE;	2198832	02/15/2022	K. SINCERBOX
C	.387± .003 WAS .39000±.00012;	2200917	08/08/2022	D. CHIN / K. SINCERBOX

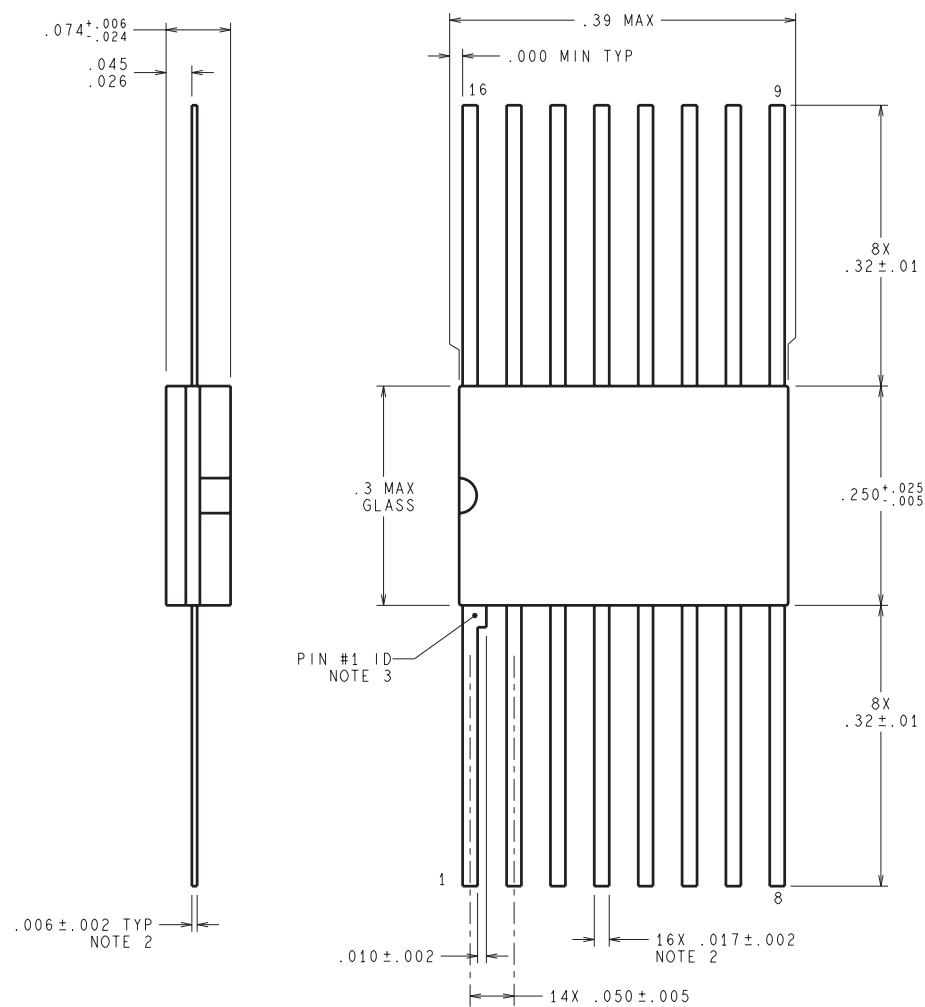
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CONTROLLING DIMENSION IS INCH
VALUES IN [] ARE MILLIMETERS

J16A (REV L)

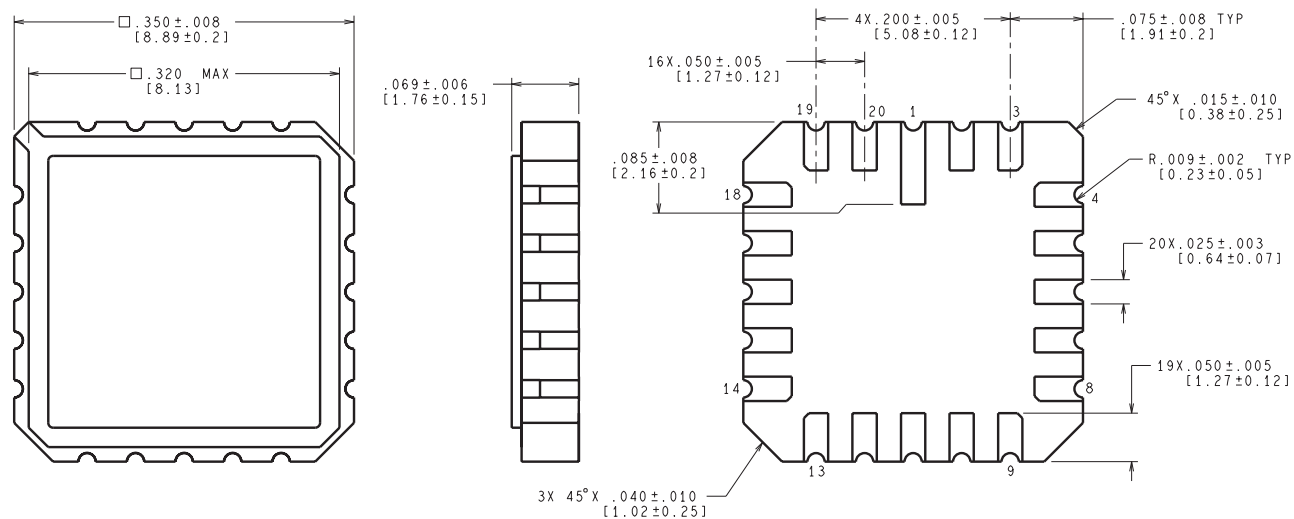
NAD0016A



DIMENSIONS ARE IN INCHES

W16A (Rev T)

NAJ0020A



CONTROLLING DIMENSION IS INCH
VALUES IN [] ARE MILLIMETERS

E20A (Rev F)

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